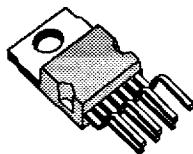


**VERTICAL DEFLECTION BOOSTER**

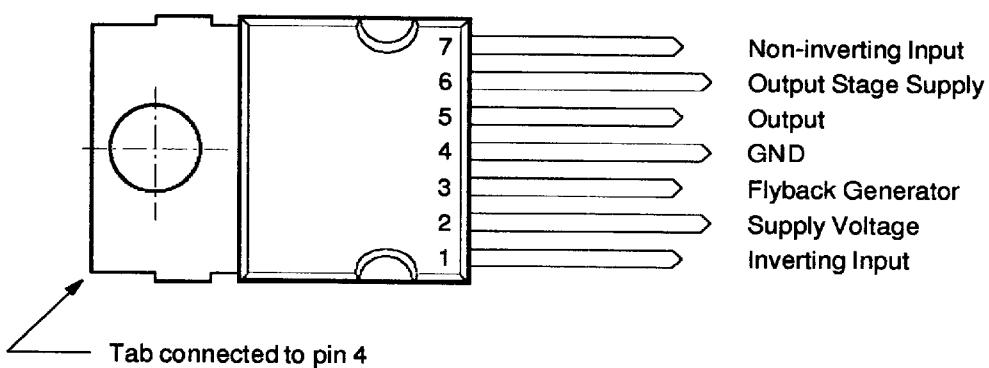
- POWER AMPLIFIER
- FLYBACK GENERATOR
- THERMAL PROTECTION
- OUTPUT CURRENT UP TO 2.0A<sub>PP</sub>
- FLYBACK VOLTAGE UP TO 90V (on Pin 5)
- SUITABLE FOR DC COUPLING APPLICATION

**HEPTAWATT**  
(Plastic Package)**ORDER CODE : STV9379****DESCRIPTION**

Designed for monitors and high performance TVs, the STV9379 vertical deflection booster delivers flyback voltages up to 90V.

The STV9379 operates with supplies up to 42V and provides up to 2App output current to drive the yoke.

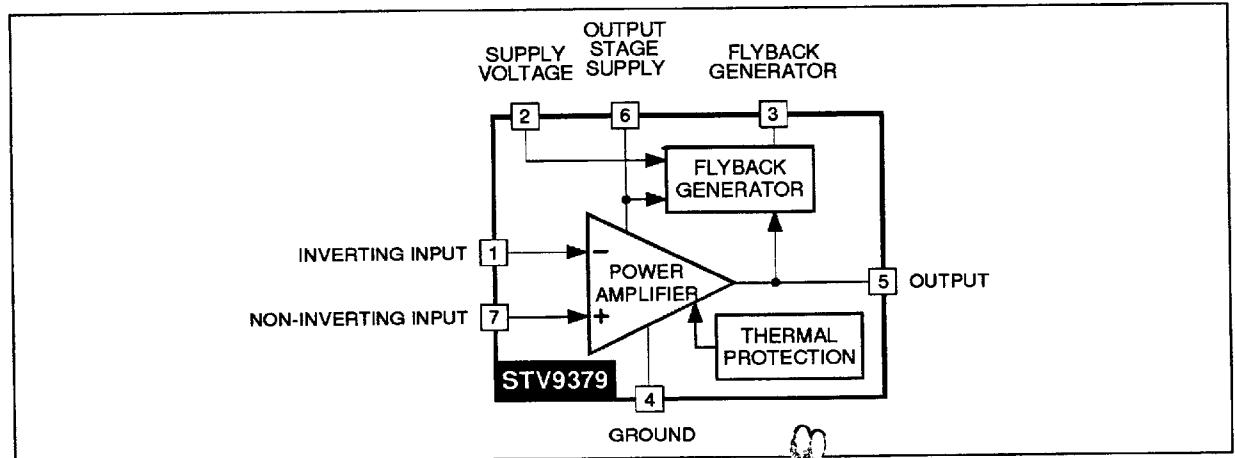
The STV9379 is offered in HEPTAWATT package.

**PIN CONNECTIONS**

9379-01.EPS

# STV9379

## BLOCK DIAGRAM



## ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$V_s$	Supply Voltage (Pin 2) (see note 1)	50	V
$V_b$	Flyback Peak Voltage (Pin 6) (see note 1)	100	V
$V_1, V_7$	Amplifier Input Voltage (Pins 1-7) (see note 1)	- 0.3, + $V_s$	V
$I_o$	Maximum Output Peak Current (see notes 2 and 3)	1.5	A
$I_3$	Maximum Sink Current (first part of flyback) ( $t < 1\text{ms}$ )	1.5	A
$I_3$	Maximum Source Current ( $t < 1\text{ms}$ )	1.5	A
$V_{ESD}$	Electrostatic Handling for all pins (see note 4)	300	V
$T_{oper}$	Operating Ambient Temperature	- 20, + 75	°C
$T_{sig}$	Storage Temperature	- 40, + 150	°C
$T_j$	Junction Temperature	+150	°C

9379-01.TBL

- Notes :**
1. Versus GND.
  2. The output current can reach 4A peak for  $t \leq 10\mu\text{s}$  (up to 120Hz).
  3. Provided SOAR is respected (see Figures 1 and 2).
  4. Equivalent to discharging a 200pF capacitor through a  $0\Omega$  series resistor.

## THERMAL DATA

Symbol	Parameter	Value	Unit
$R_{th(j-c)}$	Junction-case Thermal Resistance	Max.	°C/W
$T_t$	Temperature for Thermal Shutdown	150	°C
$\Delta T_t$	Hysteresis on $T_t$	10	°C
$T_{jr}$	Recommended Max. Junction Temperature	120	°C

9379-02.TBL

**ELECTRICAL CHARACTERISTICS**

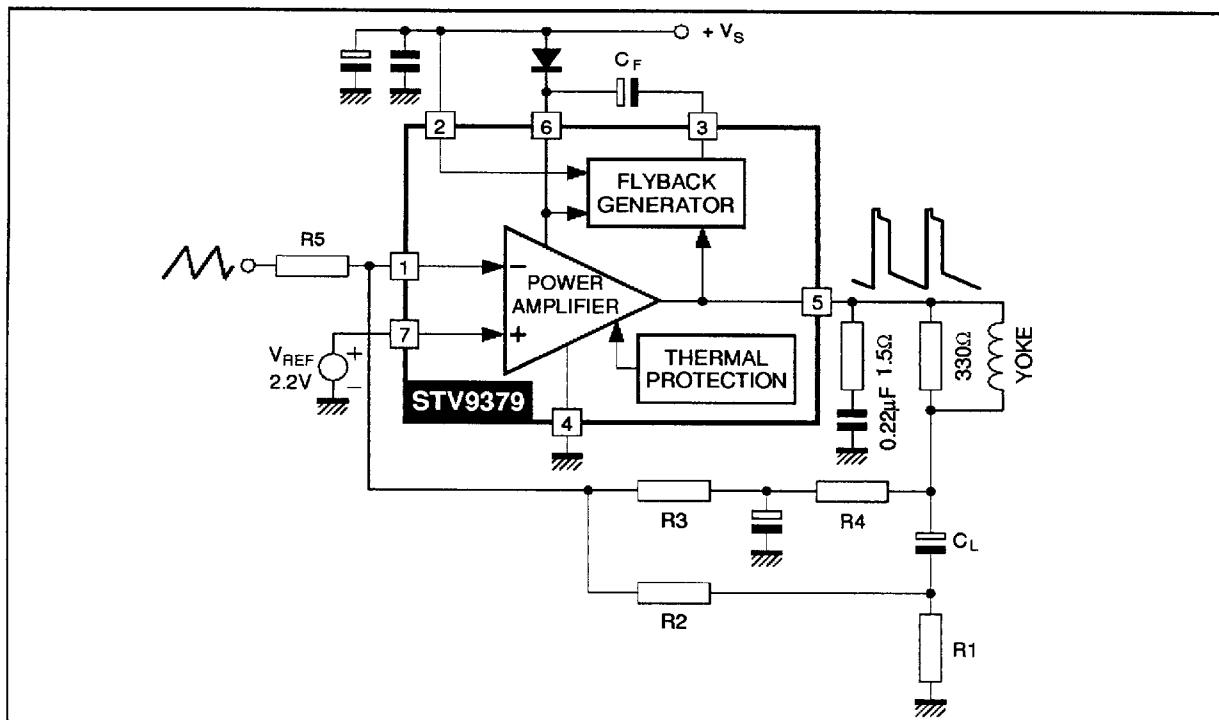
(Vs = 42V, TA = 25°C, unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Vs	Operating Supply Voltage Range		10		42	V
I2	Pin 2 Quiescent Current	I3 = 0, I5 = 0		10	20	mA
I6	Pin 6 Quiescent Current	I3 = 0, I5 = 0	5	10	30	mA
I0	Max. Peak Output Current				1	A
I1	Amplifier Bias Current	V1 = 25V, V7 = 26V		- 0.15	- 1	µA
I7	Amplifier Bias Current	V1 = 26V, V7 = 25V		- 0.15	- 1	µA
VIO	Offset Voltage				7	mV
ΔVIO/dt	Offset Drift versus Temperature			- 10		µV/°C
GV	Voltage Gain		80			dB
V5L	Output Saturation Voltage to GND (Pin 4)	I5 = 1A		1	1.5	V
V5H	Output Saturation Voltage to Supply (Pin 6)	I5 = -1A		1.6	2.1	V
VD5 - 6	Diode Forward Voltage between Pins 5-6	I5 = 1A		1.5	2	V
VD3 - 2	Diode Forward Voltage between Pins 3-2	I3 = 1A		1.5	2	V
V3L	Saturation Voltage on Pin 3	I3 = 20mA		0.8	1.2	V
V3SH	Saturation Voltage to Pin 2 (2nd part of flyback)	I3 = -1A		2.1	2.9	V

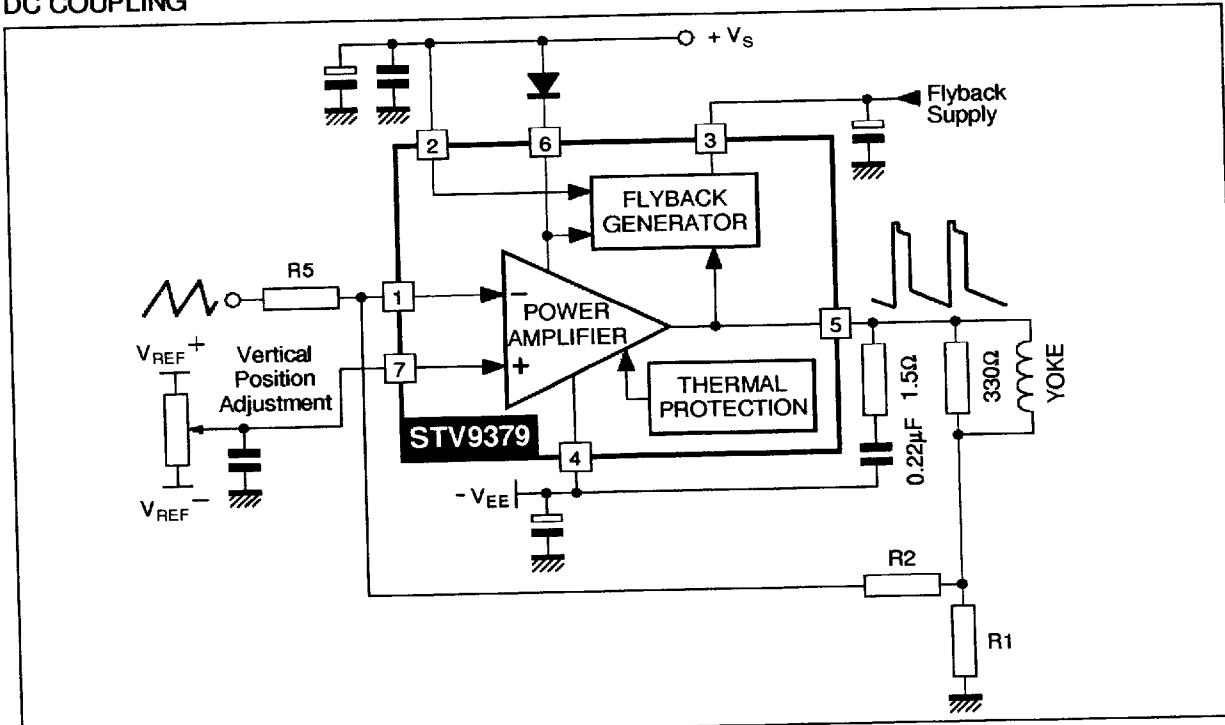
9379-03.TBL

**APPLICATION CIRCUITS**

## AC COUPLING

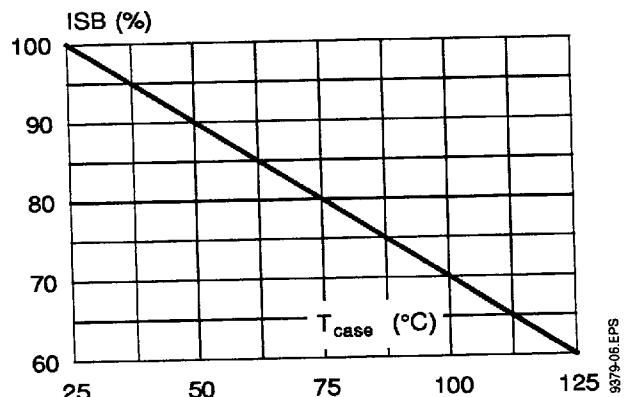
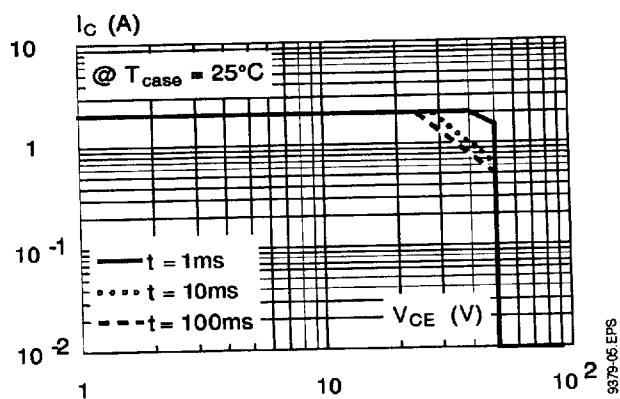


9379-03.EPS

**APPLICATION CIRCUITS (continued)**  
**DC COUPLING**


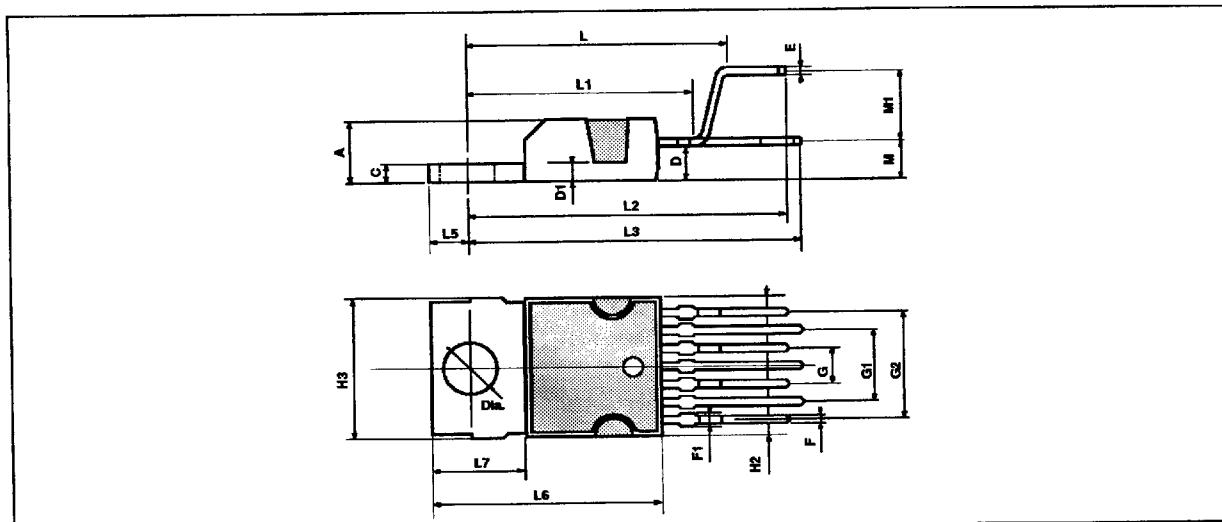
9379-04.EPS

**Figure 1 :** Output Transistors SOA  
 (for secondary breakdown)

**Figure 2 :** Secondary Breakdown Temperature  
 Derating Curve  
 (ISB = secondary breakdown current)


9379-06.EPS

## PACKAGE MECHANICAL DATA : 7 PINS - PLASTIC HEPTAWAT



PM-HEPTV.EPS

HEPTV.TBL

Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			4.8			0.189
C			1.37			0.054
D	2.4		2.8	0.094		0.110
D1	1.2		1.35	0.047		0.053
E	0.35		0.55	0.014		0.022
F	0.6		0.8	0.024		0.031
F1			0.9			0.035
G	2.41	2.54	2.67	0.095	0.100	0.105
G1	4.91	5.08	5.21	0.193	0.200	0.205
G2	7.49	7.62	7.8	0.295	0.300	0.307
H2			10.4			0.409
H3	10.05		10.4	0.396		0.409
L		16.97			0.668	
L1		14.92			0.587	
L2		21.54			0.848	
L3		22.62			0.891	
L5	2.6		3	0.102		0.118
L6	15.1		15.8	0.594		0.622
L7	6		6.6	0.236		0.260
M		2.8			0.110	
M1		5.08			0.200	
Dia.	3.65		3.85	0.144		0.152

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